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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	11024
Number of Logic Elements/Cells	99216
Total RAM Bits	8183808
Number of I/O	1040
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1704-BBGA, FCBGA
Supplier Device Package	1704-FCBGA (42.5x42.5)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp100-5ffg1704i

Figure 36, Figure 37, and Figure 38 illustrate various example configurations.

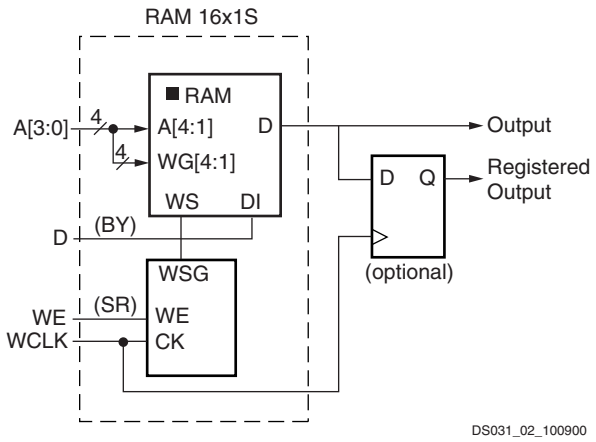


Figure 36: **Distributed SelectRAM+ (RAM16x1S)**

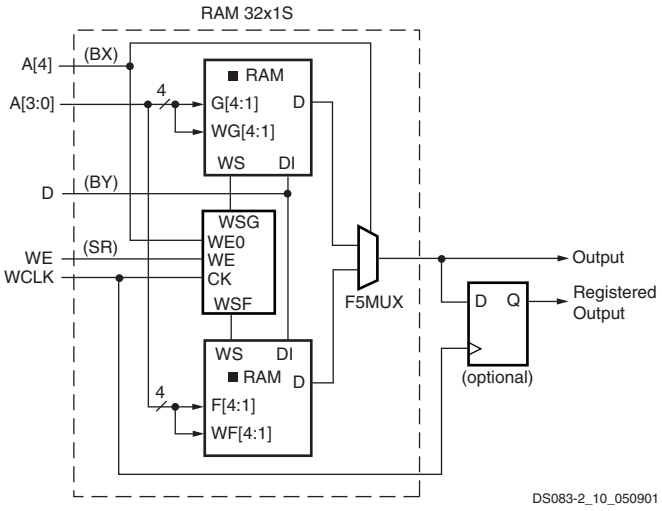


Figure 37: **Single-Port Distributed SelectRAM+ (RAM32x1S)**

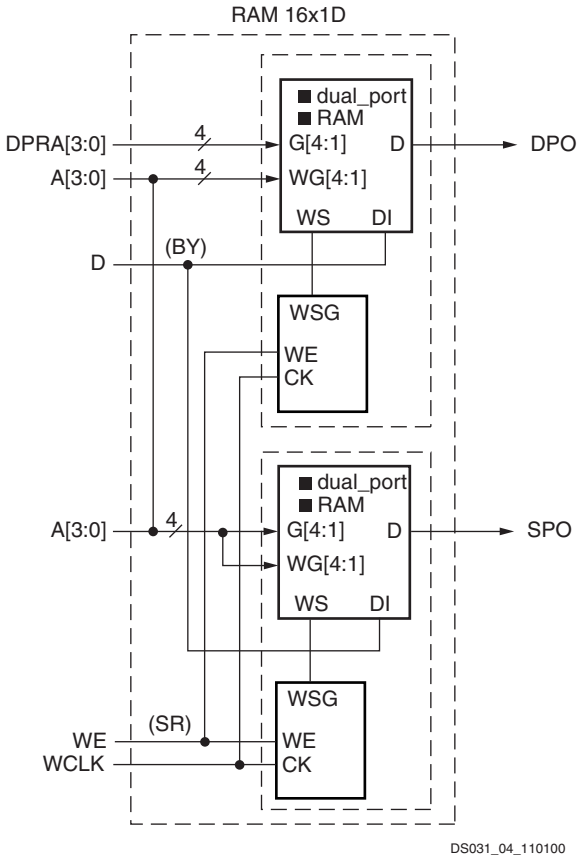


Figure 38: **Dual-Port Distributed SelectRAM+ (RAM16x1D)**

Similar to the RAM configuration, each function generator (LUT) can implement a 16 x 1-bit ROM. Five configurations are available: ROM16x1, ROM32x1, ROM64x1, ROM128x1, and ROM256x1. The ROM elements are cascadable to implement wider or/and deeper ROM. ROM contents are loaded at configuration. Table 17 shows the number of LUTs occupied by each configuration.

Table 17: **ROM Configuration**

ROM	Number of LUTs
16 x 1	1
32 x 1	2
64 x 1	4
128 x 1	8 (1 CLB)
256 x 1	16 (2 CLBs)

Sum of Products

Each Virtex-II Pro slice has a dedicated OR gate named ORCY, ORing together outputs from the slices carryout and the ORCY from an adjacent slice. The ORCY gate with the dedicated Sum of Products (SOP) chain are designed for implementing large, flexible SOP chains. One input of each ORCY is connected through the fast SOP chain to the output of the previous ORCY in the same slice row. The second input is connected to the output of the top MUXCY in the same slice, as shown in Figure 43.

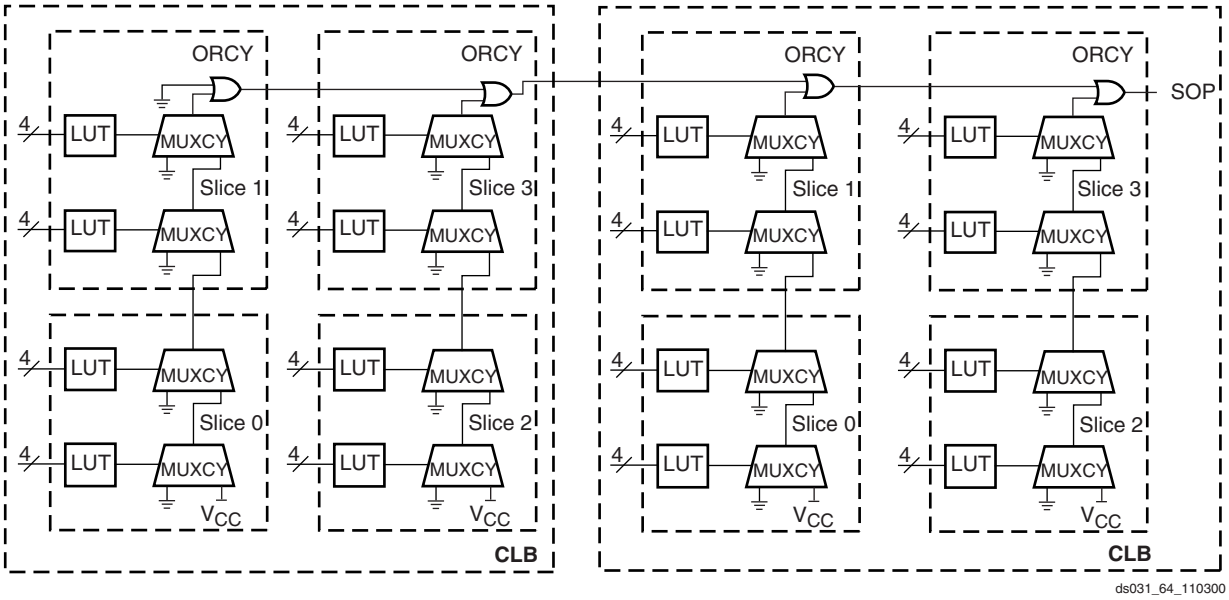


Figure 43: **Horizontal Cascade Chain**

LUTs and MUXCYs can implement large AND gates or other combinatorial logic functions. Figure 44 illustrates LUT and MUXCY resources configured as a 16-input AND gate.

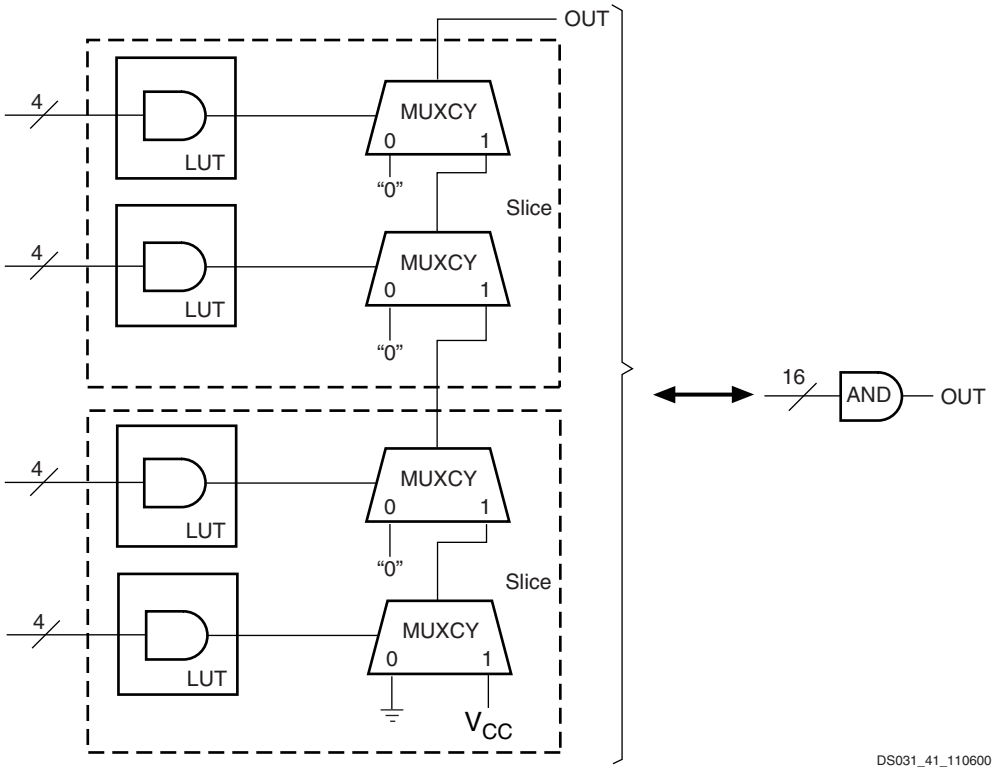


Figure 44: **Wide-Input AND Gate (16 Inputs)**

SelectIO-Ultra DC Input and Output Levels

Values for V_{IL} and V_{IH} are recommended input voltages. Values for I_{OL} and I_{OH} are guaranteed over the recommended operating conditions at the V_{OL} and V_{OH} test points. Only selected standards are tested. These are chosen to ensure that all standards meet their specifications. The selected standards are tested at minimum V_{CCO} with the respective V_{OL} and V_{OH} voltage levels shown. Other standards are sample tested.

Table 6: **DC Input and Output Levels**

IOSTANDARD Attribute	V_{IL}		V_{IH}		V_{OL}	V_{OH}	I_{OL}	I_{OH}
	V, min	V, max	V, min	V, max	V, max	V, min	mA	mA
LVTTL	–0.2	0.8	2.0	3.45	0.4	2.4	24	–24
LVCMOS33	–0.2	0.8	2.0	3.45	0.4	V_{CCO} – 0.4	24	–24
LVCMOS25	–0.2	0.7	1.7	V_{CCO} + 0.4	0.4	V_{CCO} – 0.4	24	–24
LVCMOS18	–0.2	30% V_{CCO}	70% V_{CCO}	V_{CCO} + 0.4	0.4	V_{CCO} – 0.45	16	–16
LVCMOS15	–0.2	30% V_{CCO}	70% V_{CCO}	V_{CCO} + 0.4	0.4	V_{CCO} – 0.45	16	–16
PCI33_3	–0.2	30% V_{CCO}	50% V_{CCO}	3.6	10% V_{CCO}	90% V_{CCO}		
PCI66_3	–0.2	30% V_{CCO}	50% V_{CCO}	3.6	10% V_{CCO}	90% V_{CCO}		
PCIX	–0.2	Note (1)	Note (1)	Note (1)	Note (1)	Note (1)	Note (1)	Note (1)
GTLP	–0.2	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.4	0.6	n/a	36	n/a
GTL	–0.2	V_{REF} – 0.05	V_{REF} + 0.05	V_{CCO} + 0.4	0.4	n/a	40	n/a
HSTL_I	–0.2	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.4	0.4(2)	V_{CCO} – 0.4	8(2)	–8(2)
HSTL_II	–0.2	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.4	0.4(2)	V_{CCO} – 0.4	16(2)	–16(2)
HSTL_III	–0.2	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.4	0.4(2)	V_{CCO} – 0.4	24(2)	–8(2)
HSTL_IV	–0.2	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.4	0.4(2)	V_{CCO} – 0.4	48(2)	–8(2)
SSTL2_I	–0.2	V_{REF} – 0.15	V_{REF} + 0.15	V_{CCO} + 0.3	V_{TT} – 0.61	V_{TT} + 0.61	8.1	–8.1
SSTL2_II	–0.2	V_{REF} – 0.15	V_{REF} + 0.15	V_{CCO} + 0.3	V_{TT} – 0.81	V_{TT} + 0.81	16.2	–16.2
SSTL18_I	–0.2	V_{REF} – 0.125	V_{REF} + 0.125	V_{CCO} + 0.3	V_{TT} – 0.61	V_{TT} + 0.61	6.7	–6.7
SSTL18_II	–0.2	V_{REF} – 0.125	V_{REF} + 0.125	V_{CCO} + 0.3	V_{TT} – 0.61	V_{TT} + 0.61	13.4	–13.4

Notes:
1. Tested according to relevant specifications.
2. This applies to 1.5V and 1.8V HSTL.

LDT DC Specifications (LDT_25)

Table 7: **LDT DC Specifications**

DC Parameter	Symbol	Conditions	Min	Typ	Max	Units
Supply Voltage	V_{CCO}		2.38	2.5	2.63	V
Differential Output Voltage	V_{OD}	R_T = 100 ohm across Q and $\overline{Q}$ signals	495	600	715	mV
Change in V_{OD} Magnitude	ΔV_{OD}		–15		15	mV
Output Common Mode Voltage	V_{OCM}	R_T = 100 ohm across Q and $\overline{Q}$ signals	495	600	715	mV
Change in V_{OS} Magnitude	ΔV_{OCM}		–15		15	mV
Input Differential Voltage	V_{ID}		200	600	1000	mV
Change in V_{ID} Magnitude	ΔV_{ID}		–15		15	mV
Input Common Mode Voltage	V_{ICM}		440	600	780	mV
Change in V_{ICM} Magnitude	ΔV_{ICM}		–15		15	mV

Table 38: **IOB Output Switching Characteristics Standard Adjustments *(Continued)***

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-7	-6	-5	
LVCMOS, 2.5V, Fast, 6 mA	LVCMOS25_F6	$T_{OLVCMOS25\_F6}$	0.62	0.71	0.78	ns
LVCMOS, 2.5V, Fast, 8 mA	LVCMOS25_F8	$T_{OLVCMOS25\_F8}$	0.20	0.23	0.25	ns
LVCMOS, 2.5V, Fast, 12 mA	LVCMOS25_F12	$T_{OLVCMOS25\_F12}$	0.00	0.00	0.00	ns
LVCMOS, 2.5V, Fast, 16 mA	LVCMOS25_F16	$T_{OLVCMOS25\_F16}$	–0.03	–0.03	–0.04	ns
LVCMOS, 2.5V, Fast, 24 mA	LVCMOS25_F24	$T_{OLVCMOS25\_F24}$	–0.15	–0.15	–0.15	ns
LVCMOS, 1.8V, Slow, 2 mA	LVCMOS18_S2	$T_{OLVCMOS18\_S2}$	4.20	4.83	5.31	ns
LVCMOS, 1.8V, Slow, 4 mA	LVCMOS18_S4	$T_{OLVCMOS18\_S4}$	2.76	3.18	3.49	ns
LVCMOS, 1.8V, Slow, 6 mA	LVCMOS18_S6	$T_{OLVCMOS18\_S6}$	1.91	2.20	2.41	ns
LVCMOS, 1.8V, Slow, 8 mA	LVCMOS18_S8	$T_{OLVCMOS18\_S8}$	1.92	2.20	2.42	ns
LVCMOS, 1.8V, Slow, 12 mA	LVCMOS18_S12	$T_{OLVCMOS18\_S12}$	1.58	1.81	1.99	ns
LVCMOS, 1.8V, Slow, 16 mA	LVCMOS18_S16	$T_{OLVCMOS18\_S16}$	0.76	0.87	0.96	ns
LVCMOS, 1.8V, Fast, 2 mA	LVCMOS18_F2	$T_{OLVCMOS18\_F2}$	2.34	2.69	2.95	ns
LVCMOS, 1.8V, Fast, 4 mA	LVCMOS18_F4	$T_{OLVCMOS18\_F4}$	0.71	0.81	0.89	ns
LVCMOS, 1.8V, Fast, 6 mA	LVCMOS18_F6	$T_{OLVCMOS18\_F6}$	0.50	0.57	0.63	ns
LVCMOS, 1.8V, Fast, 8 mA	LVCMOS18_F8	$T_{OLVCMOS18\_F8}$	0.48	0.55	0.61	ns
LVCMOS, 1.8V, Fast, 12 mA	LVCMOS18_F12	$T_{OLVCMOS18\_F12}$	0.30	0.34	0.38	ns
LVCMOS, 1.8V, Fast, 16 mA	LVCMOS18_F16	$T_{OLVCMOS18\_F16}$	0.11	0.12	0.13	ns
LVCMOS, 1.5V, Slow, 2 mA	LVCMOS15_S2	$T_{OLVCMOS15\_S2}$	6.19	7.12	7.83	ns
LVCMOS, 1.5V, Slow, 4 mA	LVCMOS15_S4	$T_{OLVCMOS15\_S4}$	4.28	4.93	5.42	ns
LVCMOS, 1.5V, Slow, 6 mA	LVCMOS15_S6	$T_{OLVCMOS15\_S6}$	2.81	3.24	3.56	ns
LVCMOS, 1.5V, Slow, 8 mA	LVCMOS15_S8	$T_{OLVCMOS15\_S8}$	2.55	2.93	3.23	ns
LVCMOS, 1.5V, Slow, 12 mA	LVCMOS15_S12	$T_{OLVCMOS15\_S12}$	1.31	1.51	1.66	ns
LVCMOS, 1.5V, Slow, 16 mA	LVCMOS15_S16	$T_{OLVCMOS15\_S16}$	1.28	1.47	1.62	ns
LVCMOS, 1.5V, Fast, 2 mA	LVCMOS15_F2	$T_{OLVCMOS15\_F2}$	2.26	2.60	2.86	ns
LVCMOS, 1.5V, Fast, 4 mA	LVCMOS15_F4	$T_{OLVCMOS15\_F4}$	1.66	1.90	2.09	ns
LVCMOS, 1.5V, Fast, 6 mA	LVCMOS15_F6	$T_{OLVCMOS15\_F6}$	0.65	0.75	0.82	ns
LVCMOS, 1.5V, Fast, 8 mA	LVCMOS15_F8	$T_{OLVCMOS15\_F8}$	0.94	1.08	1.19	ns
LVCMOS, 1.5V, Fast, 12 mA	LVCMOS15_F12	$T_{OLVCMOS15\_F12}$	0.25	0.29	0.32	ns
LVCMOS, 1.5V, Fast, 16 mA	LVCMOS15_F16	$T_{OLVCMOS15\_F16}$	0.28	0.32	0.35	ns
LVDS (Low-Voltage Differential Signaling), 2.5V	LVDS_25	T_{OLVDS_25}	0.01	0.01	0.01	ns
LVDSEXT (LVDS Extended Mode), 2.5V	LVDSEXT_25	$T_{OLVDSEXT\_25}$	0.13	0.15	0.16	ns
ULVDS (Ultra LVDS), 2.5V	ULVDS_25	T_{OULVDS_25}	0.13	0.14	0.16	ns
BLVDS (Bus LVDS), 2.5V	BLVDS_25	T_{OBLVDS_25}	0.00	0.00	0.00	ns
LDT (HyperTransport), 2.5V	LDT_25	T_{OLDT_25}	0.13	0.14	0.16	ns
LVPECL (Low-Voltage Positive Emitter-Coupled Logic), 2.5V	LVPECL_25	$T_{OLVPECL\_25}$	0.17	0.19	0.21	ns
PCI (Peripheral Component Interface), 33 MHz, 3.3V	PCI33_3	T_{OPCI33_3}	0.83	0.93	1.01	ns
PCI, 66 MHz, 3.3V	PCI66_3	T_{OPCI66_3}	0.89	0.97	1.05	ns
PCI-X, 133 MHz, 3.3V	PCIX	T_{OPCIX}	0.92	1.02	1.10	ns
GTL (Gunning Transceiver Logic)	GTL	T_{OGTL}	0.08	0.10	0.11	ns
GTL Plus	GTLP	T_{OGTLP}	0.04	0.05	0.06	ns
HSTL (High-Speed Transceiver Logic), Class I	HSTL_I	T_{OHSTL_I}	0.56	0.64	0.70	ns

Table 4: **Virtex-II Pro Pin Definitions *(Continued)***

Pin Name	Direction	Description
GCLKx (S/P)	Input/Output	These are clock input pins that connect to Global Clock Buffers. These pins become regular user I/Os when not needed for clocks. These pins can be used to clock the RocketIO transceiver. See the **RocketIO Transceiver User Guide** for design guidelines and BREFCLK-specific pins, by device.
VRP	Input	This pin is for the DCI voltage reference resistor of P transistor (per bank).
VRN	Input	This pin is for the DCI voltage reference resistor of N transistor (per bank).
V_{REF}	Input	These are input threshold voltage pins. They become user I/Os when an external threshold voltage is not needed (per bank).
Dedicated Pins:(1)		
CCLK	Input/Output	Configuration clock. Output in Master mode or Input in Slave mode.
PROG_B	Input	Active Low asynchronous reset to configuration logic. This pin has a permanent weak pull-up resistor.
DONE	Input/Output	DONE is a bidirectional signal with an optional internal pull-up resistor. As an output, this pin indicates completion of the configuration process. As an input, a Low level on DONE can be configured to delay the start-up sequence.
M2, M1, M0	Input	Configuration mode selection. Pin is biased by V_{CCAUX} (must be 2.5V). These pins should not connect to 3.3V unless 100Ω series resistors are used. The mode pins are not to be toggled (changed) while in operation during and after configuration.
HSWAP_EN	Input	Enable I/O pull-ups during configuration.
TCK	Input	Boundary Scan Clock. This pin is 3.3V compatible.
TDI	Input	Boundary Scan Data Input. This pin is 3.3V compatible.
TDO	Output (open-drain)	Boundary Scan Data Output. Pin is open-drain and can be pulled up to 3.3V. It is recommended that the external pull-up be greater than 200Ω. There is no internal pull-up.
TMS	Input	Boundary Scan Mode Select. This pin is 3.3V compatible.
PWRDWN_B	Input *(unsupported)*	Active Low power-down pin (unsupported). *Driving this pin Low can adversely affect device operation and configuration.* PWRDWN_B is internally pulled High, which is its default state. It does not require an external pull-up.
Other Pins:		
DXN, DXP	N/A	Temperature-sensing diode pins (Anode: DXP, Cathode: DXN).
V_{BATT}	Input	Decryptor key memory backup supply. (Connect to V_{CCAUX} or GND if battery not used.)
RSVD	N/A	Reserved pin - do not connect.
V_{CCO}	Input	Power-supply pins for the output drivers (per bank).
V_{CCAUX}	Input	Power-supply pins for auxiliary circuits.
V_{CCINT}	Input	Power-supply pins for the internal core logic.
GND	Input	Ground.
AVCCAUXRX#	Input	Analog power supply for receive circuitry of the RocketIO MGT (2.5V).
AVCCAUXTX#	Input	Analog power supply for transmit circuitry of the RocketIO MGT (2.5V).
BREFCLKN, BREFCLKP(2)	Input	Differential clock input that clocks the RocketIO X MGTs populating the same side of the chip (top or bottom). Can also drive DCMs for RocketIO X MGT use.

Table 7: **FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
0	IO_L55N_0	G12			
0	IO_L55P_0	F12			
0	IO_L57N_0	E12			
0	IO_L57P_0/VREF_0	F13			
0	IO_L67N_0	D12			
0	IO_L67P_0	C12			
0	IO_L69N_0	J13			
0	IO_L69P_0/VREF_0	H13			
0	IO_L74N_0/GCLK7P	E13			
0	IO_L74P_0/GCLK6S	D13			
0	IO_L75N_0/GCLK5P	C13			
0	IO_L75P_0/GCLK4S	B13			
1	IO_L75N_1/GCLK3P	B14			
1	IO_L75P_1/GCLK2S	C14			
1	IO_L74N_1/GCLK1P	D14			
1	IO_L74P_1/GCLK0S	E14			
1	IO_L69N_1/VREF_1	H14			
1	IO_L69P_1	J14			
1	IO_L67N_1	C15			
1	IO_L67P_1	D15			
1	IO_L57N_1/VREF_1	F14			
1	IO_L57P_1	E15			
1	IO_L55N_1	F15			
1	IO_L55P_1	G15			
1	IO_L54N_1	H15			
1	IO_L54P_1	J15			
1	IO_L53_1/No_Pair	F16			
1	IO_L50_1/No_Pair	G16			
1	IO_L49N_1	C17			
1	IO_L49P_1	D17			
1	IO_L48N_1	E16			
1	IO_L48P_1	E17			
1	IO_L46N_1	H16			
1	IO_L46P_1	H17			

Table 8: **FF672 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
2	IO_L48P_2	H1	NC		
2	IO_L49N_2	J7	NC		
2	IO_L49P_2	J6	NC		
2	IO_L50N_2	J5	NC		
2	IO_L50P_2	J4	NC		
2	IO_L51N_2	J3	NC		
2	IO_L51P_2	J2	NC		
2	IO_L52N_2/VREF_2	K6	NC		
2	IO_L52P_2	K5	NC		
2	IO_L53N_2	K4	NC		
2	IO_L53P_2	K3	NC		
2	IO_L54N_2	J1	NC		
2	IO_L54P_2	K1	NC		
2	IO_L55N_2	K7	NC		
2	IO_L55P_2	L8	NC		
2	IO_L56N_2	L7	NC		
2	IO_L56P_2	M7	NC		
2	IO_L57N_2	L6	NC		
2	IO_L57P_2	L5	NC		
2	IO_L58N_2/VREF_2	L4	NC		
2	IO_L58P_2	L3	NC		
2	IO_L59N_2	L2	NC		
2	IO_L59P_2	L1	NC		
2	IO_L60N_2	M8	NC		
2	IO_L60P_2	N8	NC		
2	IO_L85N_2	M6			
2	IO_L85P_2	M5			
2	IO_L86N_2	M4			
2	IO_L86P_2	M3			
2	IO_L87N_2	M2			
2	IO_L87P_2	M1			
2	IO_L88N_2/VREF_2	N7			
2	IO_L88P_2	N6			
2	IO_L89N_2	N5			
2	IO_L89P_2	N4			
2	IO_L90N_2	N3			
2	IO_L90P_2	N2			

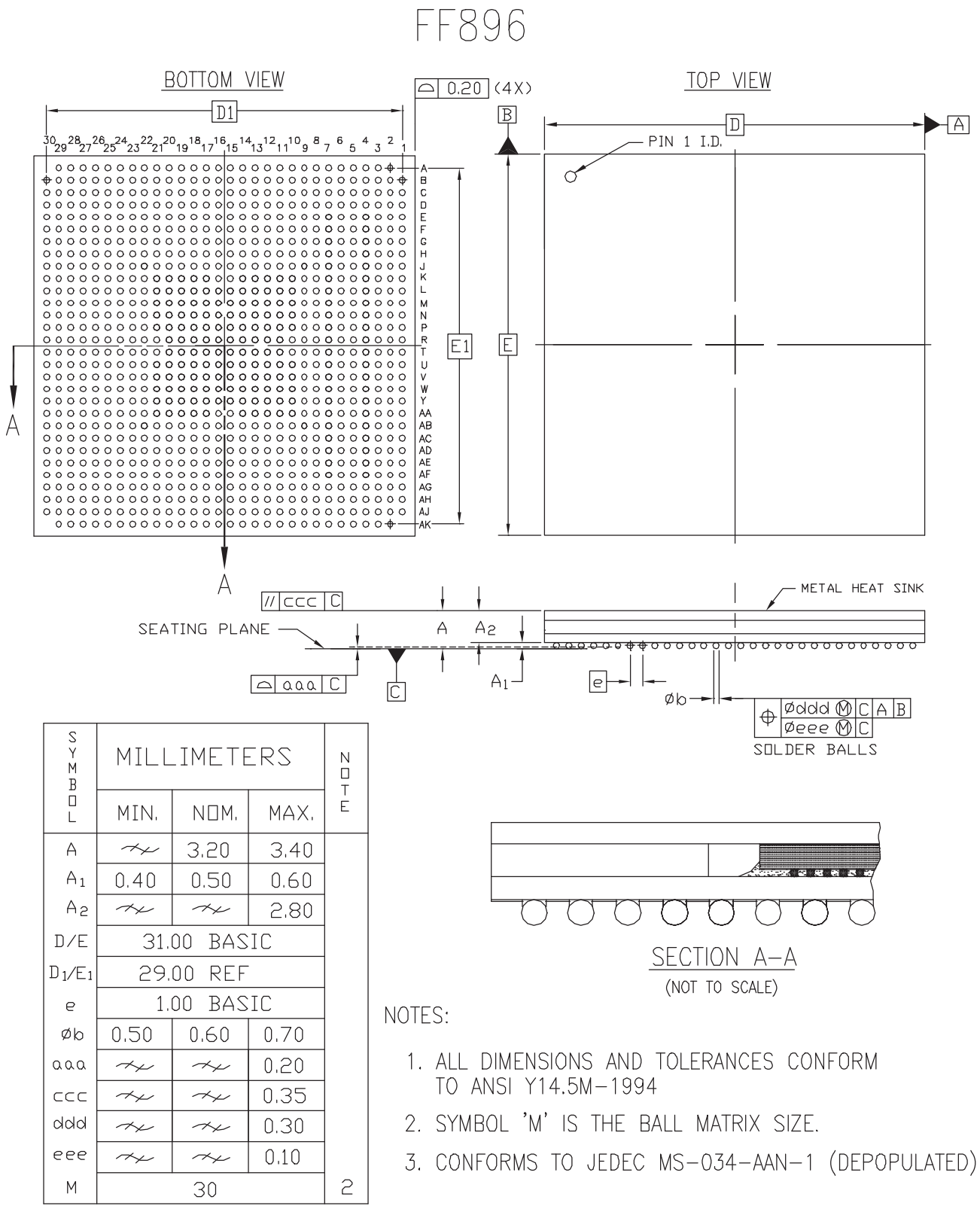
Table 8: **FF672 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
N/A	AVCCAUXRX9	B4	NC	NC	
N/A	AVCCAUXRX16	AE4	NC	NC	
N/A	VTRXPAD16	AE5	NC	NC	
N/A	RXNPAD16	AF4	NC	NC	
N/A	RXPPAD16	AF5	NC	NC	
N/A	GNDA16	AD5	NC	NC	
N/A	TXPPAD16	AF6	NC	NC	
N/A	TXNPAD16	AF7	NC	NC	
N/A	VTTXPAD16	AE7	NC	NC	
N/A	AVCCAUXTX16	AE6	NC	NC	
N/A	AVCCAUXRX18	AE9			
N/A	VTRXPAD18	AE10			
N/A	RXNPAD18	AF9			
N/A	RXPPAD18	AF10			
N/A	GNDA18	AD11			
N/A	TXPPAD18	AF11			
N/A	TXNPAD18	AF12			
N/A	VTTXPAD18	AE12			
N/A	AVCCAUXTX18	AE11			
N/A	AVCCAUXTX4	B22	NC	NC	
N/A	VTTXPAD4	B23	NC	NC	
N/A	TXNPAD4	A23	NC	NC	
N/A	TXPPAD4	A22	NC	NC	
N/A	GNDA4	C22	NC	NC	
N/A	RXPPAD4	A21	NC	NC	
N/A	RXNPAD4	A20	NC	NC	
N/A	VTRXPAD4	B21	NC	NC	
N/A	AVCCAUXRX4	B20	NC	NC	
N/A	AVCCAUXTX6	B17			
N/A	VTTXPAD6	B18			
N/A	TXNPAD6	A18			
N/A	TXPPAD6	A17			
N/A	GNDA6	C16			
N/A	RXPPAD6	A16			
N/A	RXNPAD6	A15			
N/A	VTRXPAD6	B16			
N/A	AVCCAUXRX6	B15			

Table 9: **FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30**

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
N/A	VCCINT		Y13			
N/A	VCCINT		Y12			
N/A	VCCINT		W20			
N/A	VCCINT		W11			
N/A	VCCINT		V20			
N/A	VCCINT		V11			
N/A	VCCINT		U20			
N/A	VCCINT		U11			
N/A	VCCINT		T20			
N/A	VCCINT		T11			
N/A	VCCINT		R20			
N/A	VCCINT		R11			
N/A	VCCINT		P20			
N/A	VCCINT		P11			
N/A	VCCINT		N20			
N/A	VCCINT		N11			
N/A	VCCINT		M20			
N/A	VCCINT		M11			
N/A	VCCINT		L19			
N/A	VCCINT		L18			
N/A	VCCINT		L17			
N/A	VCCINT		L16			
N/A	VCCINT		L15			
N/A	VCCINT		L14			
N/A	VCCINT		L13			
N/A	VCCINT		L12			
N/A	GND		AK22			
N/A	GND		AK9			
N/A	GND		AJ29			
N/A	GND		AJ2			
N/A	GND		AH28			
N/A	GND		AH17			
N/A	GND		AH14			
N/A	GND		AH3			
N/A	GND		AG27			
N/A	GND		AG22			

FF896 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch)



SYMBOL	MILLIMETERS			NOTE
	MIN.	NOM.	MAX.	
A		3.20	3.40	
A_1	0.40	0.50	0.60	
A_2			2.80	
D/E	31.00 BASIC			
D_1/E_1	29.00 REF			
e	1.00 BASIC			
øb	0.50	0.60	0.70	
aaa			0.20	
ccc			0.35	
ddd			0.30	
eee			0.10	
M	30			2

NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M–1994
2. SYMBOL 'M' IS THE BALL MATRIX SIZE.
3. CONFORMS TO JEDEC MS–034–AAN–1 (DEPOPULATED)

Figure 5: **FF896 Flip-Chip Fine-Pitch BGA Package Specifications**

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
1	IO_L37N_1	G13				
1	IO_L37P_1	H13				
1	IO_L27N_1/VREF_1	J13	NC	NC		
1	IO_L27P_1	K13	NC	NC		
1	IO_L26N_1	D8	NC	NC		
1	IO_L26P_1	E8	NC	NC		
1	IO_L25N_1	F12	NC	NC		
1	IO_L25P_1	G12	NC	NC		
1	IO_L21N_1	G11	NC	NC		
1	IO_L21P_1	H11	NC	NC		
1	IO_L20N_1	C7	NC	NC		
1	IO_L20P_1	D7	NC	NC		
1	IO_L19N_1	E11	NC	NC		
1	IO_L19P_1	F11	NC	NC		
1	IO_L09N_1/VREF_1	J12				
1	IO_L09P_1	K12				
1	IO_L08N_1	D6				
1	IO_L08P_1	D5				
1	IO_L07N_1	E9				
1	IO_L07P_1	F9				
1	IO_L06N_1	J11				
1	IO_L06P_1	K11				
1	IO_L05_1/No_Pair	J10				
1	IO_L03N_1/VREF_1	G10				
1	IO_L03P_1	H10				
1	IO_L02N_1	G9				
1	IO_L02P_1	H9				
1	IO_L01N_1/VRP_1	E7				
1	IO_L01P_1/VRN_1	E6				
2	IO_L01N_2/VRP_2	D2				
2	IO_L01P_2/VRN_2	D1				
2	IO_L02N_2	F8				
2	IO_L02P_2	F7				
2	IO_L03N_2	E4				
2	IO_L03P_2	E3				
2	IO_L04N_2/VREF_2	E2				
2	IO_L04P_2	E1				

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
4	IO_L47N_4	AE15		
4	IO_L47P_4	AD15		
4	IO_L48N_4	AM14		
4	IO_L48P_4	AL14		
4	IO_L49N_4	AP14		
4	IO_L49P_4	AN14		
4	IO_L50_4/No_Pair	AH15		
4	IO_L53_4/No_Pair	AG16		
4	IO_L54N_4	AK15		
4	IO_L54P_4	AJ15		
4	IO_L55N_4	AM15		
4	IO_L55P_4	AL16		
4	IO_L56N_4	AE16		
4	IO_L56P_4	AD16		
4	IO_L57N_4	AP15		
4	IO_L57P_4/VREF_4	AN15		
4	IO_L66N_4	AJ16	NC	
4	IO_L66P_4/VREF_4	AH16	NC	
4	IO_L67N_4	AN16		
4	IO_L67P_4	AM16		
4	IO_L68N_4	AG17		
4	IO_L68P_4	AF17		
4	IO_L69N_4	AJ17		
4	IO_L69P_4/VREF_4	AH17		
4	IO_L73N_4	AL17		
4	IO_L73P_4	AK17		
4	IO_L74N_4/GCLK3S	AE17		
4	IO_L74P_4/GCLK2P	AD17		
4	IO_L75N_4/GCLK1S	AN17		
4	IO_L75P_4/GCLK0P	AM17		
5	IO_L75N_5/GCLK7S	AM18		
5	IO_L75P_5/GCLK6P	AN18		
5	IO_L74N_5/GCLK5S	AD18		
5	IO_L74P_5/GCLK4P	AE18		
5	IO_L73N_5	AK18		
5	IO_L73P_5	AL18		
5	IO_L69N_5/VREF_5	AH18		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
3	IO_L47P_3	AC10		
3	IO_L46N_3	AE7		
3	IO_L46P_3	AE8		
3	IO_L45N_3/VREF_3	AE5		
3	IO_L45P_3	AE6		
3	IO_L44N_3	AB13		
3	IO_L44P_3	AC13		
3	IO_L43N_3	AE3		
3	IO_L43P_3	AE4		
3	IO_L42N_3	AE1		
3	IO_L42P_3	AE2		
3	IO_L41N_3	AD10		
3	IO_L41P_3	AD11		
3	IO_L40N_3	AF6		
3	IO_L40P_3	AF7		
3	IO_L39N_3/VREF_3	AF4		
3	IO_L39P_3	AF5		
3	IO_L38N_3	AC12		
3	IO_L38P_3	AD12		
3	IO_L37N_3	AF1		
3	IO_L37P_3	AF2		
3	IO_L36N_3	AG6		
3	IO_L36P_3	AG7		
3	IO_L35N_3	AE9		
3	IO_L35P_3	AE10		
3	IO_L34N_3	AF3		
3	IO_L34P_3	AG3		
3	IO_L33N_3/VREF_3	AG1		
3	IO_L33P_3	AG2		
3	IO_L32N_3	AE11		
3	IO_L32P_3	AE12		
3	IO_L31N_3	AH6		
3	IO_L31P_3	AH7		
3	IO_L30N_3	AG5		
3	IO_L30P_3	AH4		
3	IO_L29N_3	AD13		
3	IO_L29P_3	AE13		
3	IO_L28N_3	AH2		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
3	IO_L09P_3	AM3		
3	IO_L08N_3	AK8		
3	IO_L08P_3	AK9		
3	IO_L07N_3	AN6		
3	IO_L07P_3	AN7		
3	IO_L84N_3	AN3	NC	
3	IO_L84P_3	AN4	NC	
3	IO_L82N_3	AN1	NC	
3	IO_L82P_3	AN2	NC	
3	IO_L81N_3/VREF_3	AN5	NC	
3	IO_L81P_3	AP5	NC	
3	IO_L79N_3	AP3	NC	
3	IO_L79P_3	AP4	NC	
3	IO_L78N_3	AP1	NC	
3	IO_L78P_3	AP2	NC	
3	IO_L76N_3	AR2	NC	
3	IO_L76P_3	AR3	NC	
3	IO_L75N_3/VREF_3	AT1	NC	
3	IO_L75P_3	AT2	NC	
3	IO_L73N_3	AT5	NC	
3	IO_L73P_3	AU5	NC	
3	IO_L06N_3	AR6		
3	IO_L06P_3	AT6		
3	IO_L05N_3	AL9		
3	IO_L05P_3	AM8		
3	IO_L04N_3	AP7		
3	IO_L04P_3	AR7		
3	IO_L03N_3/VREF_3	AM9		
3	IO_L03P_3	AN9		
3	IO_L02N_3	AR8		
3	IO_L02P_3	AT8		
3	IO_L01N_3/VRP_3	AT7		
3	IO_L01P_3/VRN_3	AU7		
4	IO_L01N_4/BUSY/DOUT(1)	AT9		
4	IO_L01P_4/INIT_B	AR9		
4	IO_L02N_4/D0/DIN(1)	AK11		
4	IO_L02P_4/D1	AK12		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
N/A	GND	W20		
N/A	GND	V20		
N/A	GND	U20		
N/A	GND	T20		
N/A	GND	AC22		
N/A	GND	AB22		
N/A	GND	AA22		
N/A	GND	Y22		
N/A	GND	W22		
N/A	GND	V22		
N/A	GND	U22		
N/A	GND	T22		
N/A	GND	AD21		
N/A	GND	AC21		
N/A	GND	AB21		
N/A	GND	AA21		
N/A	GND	Y21		
N/A	GND	W21		
N/A	GND	V21		
N/A	GND	B38		
N/A	GND	AW37		
N/A	GND	AV37		
N/A	GND	AU37		
N/A	GND	AT37		
N/A	GND	D37		
N/A	GND	C37		
N/A	GND	B37		
N/A	GND	A37		
N/A	GND	AU36		
N/A	GND	AT36		
N/A	GND	D36		
N/A	GND	C36		
N/A	GND	AM35		
N/A	GND	AH35		
N/A	GND	AD35		
N/A	GND	T35		
N/A	GND	M35		
N/A	GND	H35		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
0	IO_L34N_0		E30		
0	IO_L34P_0		F30		
0	IO_L35N_0		D30		
0	IO_L35P_0		C30		
0	IO_L36N_0		M28		
0	IO_L36P_0/VREF_0		M29		
0	IO_L78N_0		K29	NC	
0	IO_L78P_0		L29	NC	
0	IO_L83_0/No_Pair		H29	NC	
0	IO_L84N_0		F29	NC	
0	IO_L84P_0		G29	NC	
0	IO_L85N_0		D29	NC	
0	IO_L85P_0		E29	NC	
0	IO_L86N_0		L28	NC	
0	IO_L86P_0		K28	NC	
0	IO_L87N_0		H28	NC	
0	IO_L87P_0/VREF_0		J28	NC	
0	IO_L37N_0		E28		
0	IO_L37P_0		F28		
0	IO_L38N_0		C29		
0	IO_L38P_0		C28		
0	IO_L39N_0		L27		
0	IO_L39P_0		M27		
0	IO_L43N_0		J27		
0	IO_L43P_0		K27		
0	IO_L44N_0		H27		
0	IO_L44P_0		G27		
0	IO_L45N_0		E27		
0	IO_L45P_0/VREF_0		F27		
0	IO_L46N_0		M25		
0	IO_L46P_0		M26		
0	IO_L47N_0		L26		
0	IO_L47P_0		K26		
0	IO_L48N_0		H26		
0	IO_L48P_0		J26		
0	IO_L49N_0		F26		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
3	IO_L77N_3		AT3		
3	IO_L77P_3		AT4		
3	IO_L76N_3		AU1		
3	IO_L76P_3		AU2		
3	IO_L75N_3/VREF_3		AU3		
3	IO_L75P_3		AU4		
3	IO_L74N_3		AV3		
3	IO_L74P_3		AW3		
3	IO_L73N_3		AV1		
3	IO_L73P_3		AV2		
3	IO_L06N_3		AW1		
3	IO_L06P_3		AW2		
3	IO_L05N_3		AT8		
3	IO_L05P_3		AU8		
3	IO_L04N_3		AT6		
3	IO_L04P_3		AU7		
3	IO_L03N_3/VREF_3		AY5		
3	IO_L03P_3		AY6		
3	IO_L02N_3		AV7		
3	IO_L02P_3		AW7		
3	IO_L01N_3/VRP_3		AV6		
3	IO_L01P_3/VRN_3		AW6		
4	IO_L01N_4/BUSY/DOUT(1)		AT9		
4	IO_L01P_4/INIT_B		AR9		
4	IO_L02N_4/D0/DIN(1)		AU9		
4	IO_L02P_4/D1		AV9		
4	IO_L03N_4/D2		AY9		
4	IO_L03P_4/D3		AW9		
4	IO_L05_4/No_Pair		AN11		
4	IO_L06N_4/VRP_4		AR10		
4	IO_L06P_4/VRN_4		AP10		
4	IO_L07N_4		AU10		
4	IO_L07P_4/VREF_4		AT10		
4	IO_L08N_4		AV10		
4	IO_L08P_4		AW10		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
5	VCCO_5		AH22		
6	VCCO_6		AU38		
6	VCCO_6		AP40		
6	VCCO_6		AL37		
6	VCCO_6		AJ39		
6	VCCO_6		AH29		
6	VCCO_6		AG34		
6	VCCO_6		AG29		
6	VCCO_6		AG28		
6	VCCO_6		AF29		
6	VCCO_6		AF28		
6	VCCO_6		AE40		
6	VCCO_6		AE29		
6	VCCO_6		AE28		
6	VCCO_6		AD29		
6	VCCO_6		AD28		
6	VCCO_6		AC38		
6	VCCO_6		AC35		
6	VCCO_6		AC29		
6	VCCO_6		AC28		
6	VCCO_6		AB29		
6	VCCO_6		AB28		
7	VCCO_7		AA29		
7	VCCO_7		AA28		
7	VCCO_7		Y38		
7	VCCO_7		Y35		
7	VCCO_7		Y29		
7	VCCO_7		Y28		
7	VCCO_7		W29		
7	VCCO_7		W28		
7	VCCO_7		V40		
7	VCCO_7		V29		
7	VCCO_7		V28		
7	VCCO_7		U29		
7	VCCO_7		U28		
7	VCCO_7		T34		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	GND		E22		
N/A	GND		E21		
N/A	GND		E5		
N/A	GND		D39		
N/A	GND		D32		
N/A	GND		D28		
N/A	GND		D15		
N/A	GND		D11		
N/A	GND		D4		
N/A	GND		C42		
N/A	GND		C41		
N/A	GND		C40		
N/A	GND		C3		
N/A	GND		C2		
N/A	GND		C1		
N/A	GND		B42		
N/A	GND		B1		
N/A	GND		N14		
N/A	GND		N29		
N/A	GND		AK14		
N/A	GND		AK29		
N/A	GND		P13		
N/A	GND		P30		
N/A	GND		AJ13		
N/A	GND		AJ30		

Notes:
1. See Table 4 for an explanation of the signals available on this pin.

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
0	IO_L11N_0	M25	NC
0	IO_L11P_0	M26	NC
0	IO_L12N_0	F26	NC
0	IO_L12P_0	G26	NC
0	IO_L18N_0	B26	NC
0	IO_L18P_0/VREF_0	C26	NC
0	IO_L46N_0	G24	
0	IO_L46P_0	G25	
0	IO_L47N_0	K26	
0	IO_L47P_0	L26	
0	IO_L48N_0	E25	
0	IO_L48P_0	F25	
0	IO_L49N_0	C24	
0	IO_L49P_0	C25	
0	IO_L50_0/No_Pair	L24	
0	IO_L53_0/No_Pair	L25	
0	IO_L54N_0	A25	
0	IO_L54P_0	B25	
0	IO_L55N_0	H23	
0	IO_L55P_0	H24	
0	IO_L56N_0	J25	
0	IO_L56P_0	K25	
0	IO_L57N_0	E24	
0	IO_L57P_0/VREF_0	F24	
0	IO_L58N_0	D23	
0	IO_L58P_0	D24	
0	IO_L59N_0	J24	
0	IO_L59P_0	K24	
0	IO_L60N_0	A24	
0	IO_L60P_0	B24	
0	IO_L64N_0	F23	
0	IO_L64P_0	G23	
0	IO_L65N_0	M22	
0	IO_L65P_0	M23	
0	IO_L66N_0	B23	
0	IO_L66P_0/VREF_0	C23	
0	IO_L67N_0	H22	